Microsoft Project Olympus V1.0 Overview

- Microsoft Azure Cloud Hardware Infrastructure
- Presentation to OCP Server Project
- 11/29/2017
Talk Outline

- Open-compute and Azure at Cloud-scale
- OCP Server Project Approach
- Microsoft Implementation
- Project Olympus Modular Architecture
  - Rack Structure, Power, and Management
  - Servers Blades
    - Base Specification
    - Various Servers
  - Server Firmware
  - Expansion Chassis
    - JBOD, JBOF, PCIe Expansion Chassis
- List of Contributed Material
- Project Olympus Sub-group within OCP Server Project
Open Compute Enables Cloud-Scale

AT MICROSOFT AZURE

- *Cloud-scale, Cloud-speed!*
- Azure servers diverse set of customers
- Efficiency is key at all levels
  - Space, Power, Cooling, Management, Material, Cost, Time
  - Performance
- Fail-Fast Model
  - Many opportunities, everchanging requirements
  - Explore several concepts concurrently
- At Cloud-scale, we need everybody’s help!
  - No one partner can execute on all angles at the same time
  - Need to work with competing partners
OCP Approach

AT OCP SERVER PROJECT

• Detailed Specification Contribution
  - Base Specification
    • Architectural Tenets guide several Designs
  - Design Specification
    • Clear Module Boundaries for a specific product based on the Base Specification
  - Product Contribution
    • Design Package, IP, and Collaterals
    • Orderable SKU

• Encourage complementary contributions
  - At System level
  - At Module level
MICROSOFT APPROACH

• Modular Interoperability for Innovation
• Copy-exact for Controlled Production
• Assurance of Supply through multi-sourcing, etc.

• Early Contribution to OCP, encouraging feedback
  − Detailed specification
  − Promote Independent Collaboration
# PROJECT OLYMPUS – OPEN SOURCE HARDWARE

<table>
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<th>Next-gen Cloud Hardware</th>
<th>Development Model</th>
<th>Industry Ecosystem</th>
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<td>Open-sourcing</td>
<td>New collaboration model with OCP community:</td>
<td>Bootstrap a vibrant ecosystem in OCP for the next generation of Datacenter Hardware</td>
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<td>leading edge Hyperscale Cloud Hardware</td>
<td>co-develop open-hardware at Cloud Speed</td>
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[http://www.opencompute.org/wiki/Server/ProjectOlympus](http://www.opencompute.org/wiki/Server/ProjectOlympus)
Establishes a baseline for cloud-scale standard deployment of datacenter management, power, cooling, and performance
PROJECT OLYMPUS RACK

The Structure
19” EIA RACK STRUCTURE

NO-FRILLS HIGH CAPACITY RACKS

- EIA-310 Standard
  - 600mm wide, 1200mm deep
  - 42U & 48U options
  - 3,000 lbs. capacity

- Features
  - Integrates with Project Olympus modules
  - Front & rear locking door, sidewall options
  - Three EIA rails for standard equipment
  - Baffles and air blocking panel options
RACK POWER & MANAGEMENT

NO-FRILLS HIGH CAPACITY RACKS

Universal Power Cord  Management
PROJECT OLYMPUS

Power
UNIVERSAL POWER

A/C POWER ADAPTED TO YOUR DATACENTER

• Supports high availability data centers
  - Dual-feed, three-phase A/C
  - Rack power monitoring and capping

• Universal Power Distribution
  - Distributes power and management
  - Integrated Rack Manager
  - Supports blind-mate servers

• A/C power cord adaptation
  - Racks never change, only A/C cord
    • 208V-30A, 208V-50A, 415V-30A, 400V-32A
BLADE POWER SUPPLY

OPTIMIZED FOR EFFICIENCY, RELIABILITY, HYPERSCALE DATACENTERS

• Three x 340W PSUs Fully Integrated
  − Three-phase balanced AC power
  − 680W N+1 (1020W total)
  − Dual-feed auto-selection (IVS)

• Fault Mode Resiliency
  − AC feed failure, automatic fail over
  − PSU failure caps power if necessary
  − N+1 HA => no repair on failure
  − Double fault will be extremely rare
PROJECT OLYMPUS
RACK MANAGEMENT
RACK MANAGEMENT

DRIVING UP DATACENTER UTILIZATION

- Rack Management
  - Restful API I/F or Redfish via Ethernet
  - Rack Manager (RM) ARM CPU
  - Integrated into PDU
- Blade Management flexible to your needs
  - GbE I/F to each blade’s BMC
  - NCSI enabled, cable to OCP Mezz Carrier
  - KVM enabled on motherboard
- Standalone, 1U rack mount version
  - For hardware that does not use the PDU
STANDALONE RACK MANAGER

- 1U Rack Manager Assembly
- Reuse of Rack Manager
- Supports Non-Olympus Rack Management
- Support Row Management
- Redundant AC Input
- Single SW image
Rack Manager Overview

- **Rack Manager Functions**
  - Power Management
  - Out-of-band Server Management
  - Protocol abstraction, IPMI, Redfish.

- **RM Instances in Cloud**
  - Discrete (Consumes 1U)
  - Integrated into PMDU

- **Communication**
  - Network
  - TTY Console

- **Hardware Signaling**
  - Server Presence
  - Server On/Off
  - Server Throttle

- **Security**
  - Secure Boot
  - BMC authentication

- **Power Metering & Control**
  - Protocol abstraction, IPMI, Redfish.

- **Remote Debug**
  - Kernel Debug
  - HW Debug (JTAG / ITP)
  - Logs / Telemetry

- **Remote Media**

- **Out of band FW update and recovery**
  - UEFI, CPLD, FPGA, PSU

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Fabric

Rack Boundary

Rack Manager

Switch

Server  Blade
Server  Blade
Blade  Blade
Blade  Blade
Blade  Blade
Blade  Blade
Blade  Blade
Blade  Blade

Blade  Blade
Blade  Blade
Blade  Blade
Rack Manager Block Diagram

- **To Fabric**
- **To Mgmt. Switch**
- **Debug**
- **1GB DDR3L**
- **PCIe x16 edge finger & PCIe x8 edge finder to Interface with PMDU or backplane**
- **LEDs – Attention, Power, Debug, Status**
- **Temp Sensor**
- **Humidity Sensor**
- **FRU**
- **GPIO Buffers**
  - x48 for Blade presence
  - x48 for Blade enable
  - GPIOs for Boot strap, Throttle bypass, power control etc.
- **QSPI**
- **eMMC**
- **To DIGI**
- **To Mgmt. Switch**

**Key Components:**
- **AM4376**
- **UART1**
- **UART2**
- **GPIOs**
- **LEDs**
- **ATTN LED**
- **Temp Sensor**
- **Humidity Sensor**
- **FRU**
- **Temp Monitor**
- **GPIOs for Boot strap, Throttle bypass, power control etc.**
- **QSPI**
- **eMMC**
- **1GB DDR3L**
**Auth at Interface:**
- Ethernet / REST
- CLI / TTY

**Privilege:**
- Permissions token
- Log / Audit

**Execution**
- Task execution
- Logical to Physical

**Action**
- Hardware Control
RACK MANAGEMENT
LESSONS LEARNED

• ARM vs. X86
• Linux vs. Windows
• GbE vs. RS232
• Rack vs. 12U Chassis
• Redfish vs. custom API
RACK MANAGEMENT
WHAT’S NEW

• Rack/Row/DC level Dynamic Power Capping
• Presence and Slot-ID
• Remote JTAG debug
• OoB FW update
• Odata client for auto-discovery
PROJECT OLYMPUS
Servers
PROJECT OLYMPUS 1U Universal Server
(Base Specification)
Collaborative work with Industry CPU Leaders

- **US1-XSP:** Project Olympus 1U Server Motherboard, based on a dual-socket SXP CPU Platform from Intel
- **US1-EPYC:** A Motherboard and Server Design around dual-socket x86 CPU on EPYC Platform from AMD
- **US1-THX2:** A Motherboard and Server Design around dual-socket ARM64 ThunderX2 SoC from Cavium
- **US1-Centriq:** A Motherboard and Server Design around single-socket ARM64 Centriq™ SoC from Qualcomm
PROJECT OLYMPUS
Intel XSP-based 1U Universal Server (US1-XSP)

US1-Xeon

Intel® Xeon® Scalable Platform

GBE Redfish Management

DDR4 memory
24 DIMM slots

NCSI, KVM, OCP mezz enabled

3 PCI-E x16 FHHL slots

Up to 16 M.2 CloudSSD

wiwyn

Microsoft
PROJECT OLYMPUS
AMD EPYC-based 1U, 2S Server
(US1-EPYC)

US1-EPYC

3 PCIe x16 FHHL slots
GbE Redfish Management
NCSI, KVM, OCP mezz enabled

DDR4 Memory 32 DIMM Slots
Up to 16 M.2 Cloud SSD
PROJECT OLYMPUS
Cavium THX2-based 1U, 2S Server
(US1-THX2)

Two THX2 SoCs

3 PCI-E x16 FHHL slots

DDR4 memory
24 DIMM slots

Up to 16 M.2 CloudSSD

US1-THX2
OTHER MOTHERBOARDS

DROP IN OR ADAPT TO PROJECT OLYMPUS UNIVERSAL SERVER CHASSIS

One ARM64 SoC
Various PCIe Riser Options

US1-Centriq

DDR4 Memory
12 DIMM Slots
PROJECT OLYMPUS
System Firmware
CLOUD UEFI

- Mostly written in C. High code re-use.
- Better platform scaling. For e.g. removes shadow ROM limits.
- Storage. GPT removes 2.2 TB MBR restriction.
- CPU Architecture independent. Platform design flexibility.
- Secure boot solves “trust” related system integration challenges.
- Pre-boot Networking. IPv4, IPv6, PXE, VLAN, iSCSI etc.
- UEFI shell improves pre-boot testing & diagnostics experience.
SALIENT UEFI FEATURES

- Standards
  - UEFI 2.6+
  - PI 1.3+
  - SMBIOS 3.0
  - ACPI 6.1
  - TCG
  - TPM 2.0
  - PCI 3.0
  - USB 3.0 / USB 2.0

- Security
- Serviceability
  - IPMI

- Boot Target variety
  - Network, M.2, SATA, etc.

- Binary consolidation
PROJECT OLYMPUS
Expansion Chassis
## Project Olympus Expansion Chassis

- **DX-88**  JBOD with 88 HDDs
- **FX-16**  JBOF with 16 SSD Carriers
- **HGX-1**  Hyperscale GPU Accelerator
Expansion Chassis

**DX-88 JBOD**

- 4U JBOD
- 88 Hot-plug HDDs
- N+1 Dual Rotor Fans
- N+N Redundant, 1650W 3-Phase, Hot-Swap PSUs
- Drawer design – slide out for service
- Robust Feature Set
  - Integrates into Project Olympus Infrastructure through Universal PDU
  - Runs on OpenBMC
    - Gathers HDD temps and component status info
    - Individual HDD on/off to minimize NTF
Expansion Chassis

**FX-16 JBOF**

- Project Olympus PSU
- N+2 Fans
- 1GbE RJ45
- External Host Cabling PCIe x16
- 16 Storage Carriers
- External Host Cabling PCIe x16
- PCIe Switch Board
- Paddle Boards
- Internal Cabling

Project Olympus Chassis (leveraged)
PROJECT OLYMPUS HYPERSCALE GPU ACCELERATOR (HGX-1)

- Configurable and Flexible Accelerators
  - 8 x NVIDIA V100_SXM2 & NVLink
  - 8 x GPGPUs in PCIe Card Form Factor
- Expandable to Scale UP
  - From one to four Chassis
  - Internal PCIe Fabric Interconnect
- Scale Out via InfiniBand Fabric
- Host Head Node Options
  - 2S Project Olympus Server
  - 1S, 2S, 4S Server Head Nodes (eight x16 PCIe Links)
  - Up to 16 Head Nodes (sixteen x8 PCIe Links)
Summary

Cloud-scale, Cloud-speed!

- Azure servers diverse set of customers
- Efficiency is key at all levels

- At Cloud-scale, we need everybody’s help!

- Early Contribution to OCP, encouraging feedback
  - Modular Architecture
  - Detailed specification
  - Promote Independent Collaboration and Interoperable Components
HOW TO DOWNLOAD

PROJECT OLYMPUS V1.0 CONTRIBUTIONS

http://www.opencompute.org/wiki/Server/ProjectOlympus
PROJECT OLYMPUS V1.0 CONTRIBUTIONS (NOV 2017)

Servers:
- Project Olympus Chassis Mechanical Base Specification
- Project Olympus 1U Server Mechanical Specification
- Project Olympus 2U Server Mechanical Specification
- Project Olympus Universal Motherboard Base Specification
- Project Olympus Intel XSP Motherboard Specification
  Design Package: [http://files.opencompute.org/oc/public.php?service=files&t=fa1435ef86ea3ab831bc1fc229e709e6&download](http://files.opencompute.org/oc/public.php?service=files&t=fa1435ef86ea3ab831bc1fc229e709e6&download)
- Project Olympus Intel BIOS Specification
- Project Olympus AMD EPYC Motherboard Specification
- Project Olympus Cavium ThunderX2 ARM64 Motherboard Specification

Expansion Chassis:
- Project Olympus HGX-1 PCIe Expansion Chassis Specification
- Project Olympus DX-88 JBOD Specification
- Project Olympus DX-88 Power Supply Specification

Rack:
- Project Olympus Rack Base Specification
- Project Olympus Air Blocker Specification

Management:
- Project Olympus Universal Power and Management Distribution Unit Specification (PMDU)
- Project Olympus Rack Manager Specification
- Project Olympus Standalone Rack Manager Specification

Power:
- Project Olympus Power Cord Specification
- Project Olympus Server Power Supply Specification
- Project Olympus Power Supply Software Interface Specification
- Project Olympus PDU Specification
MARCH 2017 OCP SUMMIT

• Microsoft Project Olympus Overview - [video], [slides]
• Microsoft Project Olympus Servers - [video], [slides]
• Microsoft Project Olympus High Density Flash - [video], [slides]
• Microsoft Project Olympus Storage JBOD - [video], [slides]
• Microsoft Project Olympus Hyperscale GPU Accelerator Chassis (HGX-1) - [video], [slides]
• Microsoft Project Olympus Rack Management - [video], [slides]
• Microsoft Power capping in Project Olympus - [video], [slides]
GET INVOLVED (PROJECT OLYMPUS SUB-GROUP)

• Project Olympus is Microsoft's next generation rack-level solution that is open-sourced through Open Compute Project. (Video Introduction)

• The charter of Project Olympus sub-group within OCP Server Project is to enable the OCP community to further explore, invent, collaborate, enhance, and produce great solutions for customers using Project Olympus modular building blocks.

• Initially introduced in November 2016 and with V1.0 contribution in November 2017, Project Olympus addresses several cloud workloads for Microsoft Azure.

• Since inception, Project Olympus has attracted a large group of partners such as compute silicon providers, ODMs, OEMs, and component manufacturers. It is becoming the de facto open-compute standard for cloud workloads.

• Project Olympus base specification defines a modular architecture with clear internal and external interfaces. Hardware modules include Rack, Universal PDU, Rack Manager, 1U/2U Server and mechanical Enclosures, Power Supply, Universal Motherboard, PCIe Riser Boards, and Expansion Modules for storage and accelerators; while, Software/Firmware components include RESTful API, Rack Manager Software/Firmware interface, BMC Firmware, System BIOS/UEFI Firmware, and Software APIs.

• Project Olympus comprises these Hardware and Software Modules to realize a holistic rack architecture; however, individual Modules are applicable to Racks, Chassis, Rack Managers, PDUs, PSUs, Blades and Motherboards from other architectures such as OCP Open Rack, Open Rack 19, Scorpio, 19” EIA Rack, Rack-mount Servers, and Tower Servers.

• While, Microsoft is planning Design and Product implementations based on Project Olympus specification, we encourage the community to use as-is, buy/sell as-is, modify to use or sell, and to provide feedback on any of these software or hardware Modules.

• Find other material on Project Olympus Sub-group at Wiki Page.

• To get on the sub-group mailing list, go to here.